

# **Products & Applications**

## Soldering and Rework System

Cartridge heater technology provides soldering and rework performance to suit even the most demanding SMT removal and placement applications. The cartridges provide fast thermal performance and respond quickly to the load demands. A small shaft diameter provides access to tightly cramped rework areas and enables the most difficult operations to be performed effortlessly.

MFR-SRC SOLDERING & REWORK SYSTEM				
Part No.	Description			
MFR-SRC	Soldering and Rework System			
INCLUDES				
MFR-PS1K	Two Port Universal Voltage Power Supply			
MFR-HSR	Soldering and Rework Hand-piece			
MFR-WSSR	Soldering Workstand			

Contents subject to change without notice

#### **Standard Soldering Tip Cartridges**

The Standard Soldering Tip Cartridges are used with the MFR-HSR Soldering & Rework Hand-piece and have been designed to deliver outstanding performance for the majority of point-to-point



#### **Technical Specifications**

MFR-PTZ, MFR-SRC, MFR-PST, MFR-STZ

Ambient Operating Temperature:10- 40°C

Maximum Enclosure Temperature:55°C

Input Line Voltage:100- 240 VAC, grounded circuit

Input Line Frequency: 50/60 Hz

Power Consumption: 65 Watts max.

**Output Power:** 

50 Watts max. at 22°C ambient temperature

Output Frequency:450 KHz

Power Cord 3-Wire:183cm (18/3") SJT

Power Supply Dimensions w x d x h:

122mm x 200mm x 152.5mm (4.8" x 8" x 6")

Agency Tested Per: IEC 61000-6-1, EC 61000-6-3 and

UL499, FCC CFR Part 15

Tip-to-Ground Potential: < 2mV

Tip-to-Ground Resistance: < 2 ohms

Idle Temperature Stability: ± 1.1°C in still air

Hand-piece Cable Length:

L=71cm (48"), burn proof, ESD safe

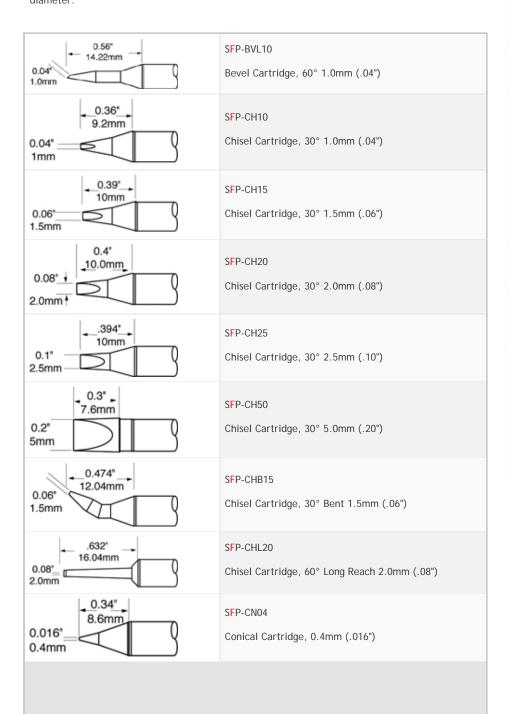
Connector:8-pin power connector

Workstand Dimensions w x d x h:

100 mm x 200 mm x 100 mm (4" x 8" x 4")

deliver maximum accessibility combined with optimal thermal efficiency within a narrow cartridge diameter.

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#### **Soldering Tip Heater Options**

With hand soldering, the task is to make a quality solder connection, without damaging the substrate and without negatively impacting throughput. All of the standard MFR Series power tips & rework cartridges are designed for use with glass fiber (FR4) PCB substrates. This is denoted by the second letter in the part number: "F". For example: SFP-CH10, DFP-CN3, and SFV-CNL10.

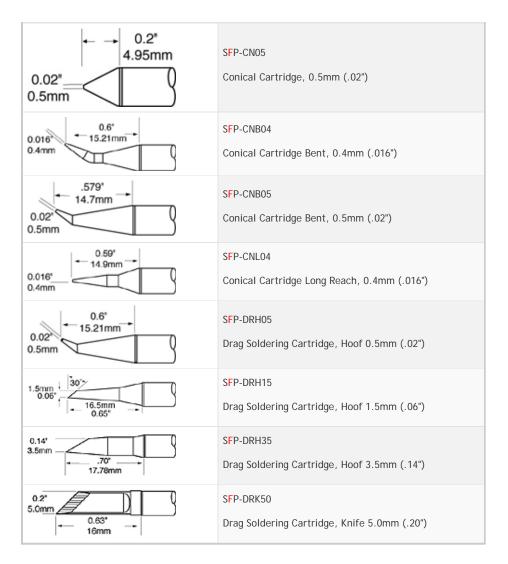
However, some specialist applications require working with thermally demanding or temperature sensitive substrates, such as ceramic hybrids or flexible circuits. OK International has developed specialty heaters that quickly deliver the necessary power, but operate at temperatures that minimize the risk of substrate damage. These are denoted by replacing the "F" in the part number with a "T" for temperature sensitive or a "C" for demanding loads. Please contact your local representative for information and availability of specialty tip heaters. For example: STP-CH10 and DCP-CN3.

F = Standard FR4 Substrate

T = Temperature

Sensitive

C = Ceramic or Heavy Load



To order specialty versions of the Soldering Tip Cartridges replace the "F" in the part number with the appropriate letter designate for your application when ordering:

T = Temperature Sensitive C = Ceramic or Heavy Load

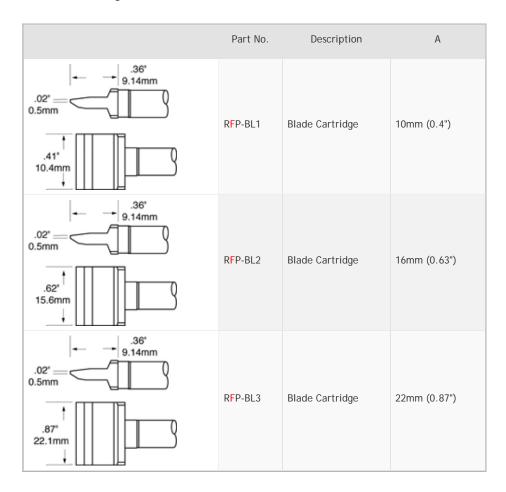
#### **Rework Cartridges**

The Rework Cartridges are used with the MFR-HSR Soldering & Rework Hand-piece for conduction rework of surface mount components. The geometries are compatible with common SMT Chip and SOIC components.



MFR-SMT in Action

### **Blade Cartridges**



# Slot Cartridges

	Part No.	SMT Type	А
.07" 1.78mm .092" 2.34mm	RFP-SL1	0805 Chip Package	2.34mm (.092")



### **Tunnel Cartridges**

Dimensions in mm (")

	Part No.	SMT Type	A2	А	В	D
A AZ	RFP- DL1	SOIC 14-16	5.18 (.204)	5.18 (.204)	4.32 (.17)	3.22 (.127)
	RFP- DL2	SOIC 8	5.18 (.204)	5.18 (.204)	4.32 (.17)	2.29 (.090)
	RFP- DL13	SOIC 16	6.86 (.270)	6.86 (.270)	11.18	2.29 (.090)

## **Quad Cartridges**

Dimensions in mm (")

	Part No.	SMT Type	A2	А	B2	В	D
B D D D	RFP- QD4	PLCC 32	11.43 (.450)	12.70 (.500)	13.97 (.550)	15.24 (.600)	3.81 (.150)

RFP- QD6	PLCC 44	16.76 (.660)	17.78 (.700)	16.76 (.660)	17.78 (.700)	3.81 (.150)
RFP- QD7	PLCC 68	24.38 (.960)	25.27 (.995)	24.38 (.960)	25.27 (.995)	5.59 (.220)
RFP- QD10	PLCC 52	19.30 (.760)	20.32 (.800)	19.30 (.760)	20.32 (.800)	3.81 (.150)
RFP- QD15	TQFP 80	12.32 (.485)	13.34 (.535)	12.32 (.485)	13.34 (.535)	2.79 (.110)
RFP- QD19	QFP 44	16.13 (.635)	16.13 (.635)	16.13 (.635)	16.13 (.635)	3.30 (.130)
RFP- QD20	QFP 100	16.51 (.650)	16.51 (.650)	22.48 (.885)	22.48 (.885)	3.30 (.130)

The second digit denotes substrate material (damage tolerance).  $\mathbf{F} = FR4 / Glass \ Fiber$ , for most standard applications. Two other series are also available; just replace F with either T or C.

T = Temperature Sensitive C = Ceramic or Heavy Load



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